

N-channel 600 V, 0.580 Ω typ., 5.5 A MDmesh II Plus™ low Qg Power MOSFET in a PowerFLAT™ 5x6 HV package

Datasheet - production data

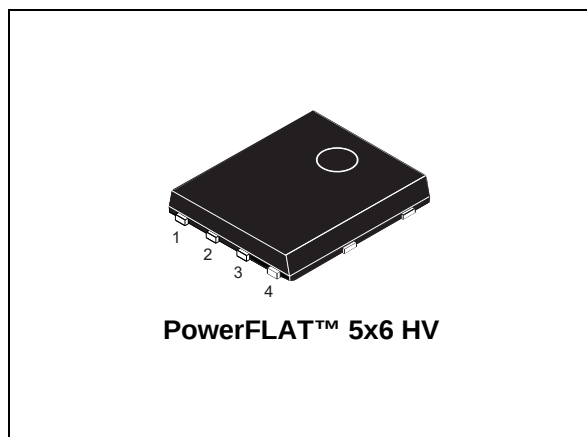
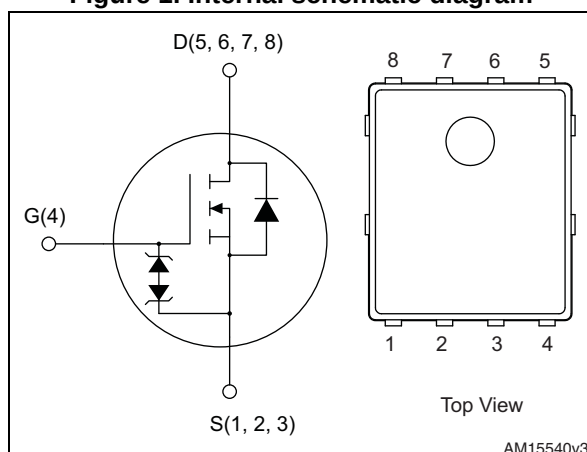


Figure 1. Internal schematic diagram



Features

Order code	$V_{DS} @ T_{Jmax}$	$R_{DS(on)} max$	I_D
STL10N60M2	650 V	0.660 Ω	5.5 A

- Extremely low gate charge
- Lower $R_{DS(on)}$ x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications

Description

This device is an N-channel Power MOSFET developed using a new generation of MDmesh™ technology: MDmesh II Plus™ low Qg. This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

Table 1. Device summary

Order code	Marking	Package	Packaging
STL10N60M2	10N60M2	PowerFLAT™ 5x6 HV	Tape and reel

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 25	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25\text{ }^{\circ}\text{C}$	5.5	A
$I_D^{(1)}$	Drain current (continuous) at $T_C = 100\text{ }^{\circ}\text{C}$	3.5	A
$I_{DM}^{(2)}$	Drain current (pulsed)	22	A
$P_{TOT}^{(2)}$	Total dissipation at $T_C = 25\text{ }^{\circ}\text{C}$	48	W
I_{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_j max)	1.5	A
E_{AS}	Single pulse avalanche energy (starting $T_j = 25\text{ }^{\circ}\text{C}$, $I_D = I_{AR}$, $V_{DD} = 50\text{ V}$)	110	mJ
$dv/dt^{(3)}$	Peak diode recovery voltage slope	15	V/ns
$dv/dt^{(4)}$	MOSFET dv/dt ruggedness	50	V/ns
T_{stg}	Storage temperature	- 55 to 150	$^{\circ}\text{C}$
T_j	Max. operating junction temperature	150	$^{\circ}\text{C}$

1. The value is limited by package
2. Pulse width limited by safe operating area
3. $I_{SD} \leq 5.5\text{ A}$, $di/dt \leq 400\text{ A}/\mu\text{s}$, $V_{DSpeak} \leq V_{(BR)DSS}$, $V_{DD} = 80\% V_{(BR)DSS}$
4. $V_{DS} \leq 480\text{ V}$

Table 3. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case max	2.6	$^{\circ}\text{C}/\text{W}$
$R_{thj-amb}^{(1)}$	Thermal resistance junction-amb max	59	$^{\circ}\text{C}/\text{W}$

1. When mounted on 1inch² FR-4 board, 2 oz Cu

2 Electrical characteristics

($T_C = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1\text{ mA}$, $V_{GS} = 0$	600			V
I_{DSS}	Zero gate voltage drain current ($V_{GS} = 0$)	$V_{DS} = 600\text{ V}$			1	μA
		$V_{DS} = 600\text{ V}$, $T_C = 125\text{ }^{\circ}\text{C}$			100	μA
I_{GSS}	Gate-body leakage current ($V_{DS} = 0$)	$V_{GS} = \pm 25\text{ V}$			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$	2	3	4	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10\text{ V}$, $I_D = 2.5\text{ A}$		0.580	0.660	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{DS} = 100\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0$	-	400	-	pF
C_{oss}	Output capacitance		-	22	-	pF
C_{rss}	Reverse transfer capacitance		-	0.84	-	pF
$C_{oss\text{ eq.}}^{(1)}$	Output equivalent capacitance	$V_{DS} = 0\text{ to }480\text{ V}$, $V_{GS} = 0$	-	83	-	pF
R_G	Intrinsic gate resistance	$f = 1\text{ MHz}$ open drain	-	6.4	-	Ω
Q_g	Total gate charge	$V_{DD} = 480\text{ V}$, $I_D = 7.5\text{ A}$, $V_{GS} = 10\text{ V}$ (see Figure 15)	-	13.5	-	nC
Q_{gs}	Gate-source charge		-	2.1	-	nC
Q_{gd}	Gate-drain charge		-	7.2	-	nC

1. $C_{oss\text{ eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS} .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 300\text{ V}$, $I_D = 3.75\text{ A}$, $R_G = 4.7\text{ }\Omega$, $V_{GS} = 10\text{ V}$ (see Figure 19)	-	8.8	-	ns
t_r	Rise time		-	8	-	ns
$t_{d(off)}$	Turn-on delay time		-	32.5	-	ns
t_f	Fall time		-	13.2	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		5.5	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		22	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 7.5 \text{ A}$, $V_{GS} = 0$	-		1.6	V
t_{rr}	Reverse recovery time	$I_{SD} = 7.5 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 60 \text{ V}$ (see Figure 16)	-	270		ns
Q_{rr}	Reverse recovery charge		-	2		μC
I_{RRM}	Reverse recovery current		-	14.4		A
t_{rr}	Reverse recovery time	$V_{DD} = 60 \text{ V}$ $di/dt = 100 \text{ A}/\mu\text{s}$, $I_{SD} = 7.5 \text{ A}$ $T_j = 150^\circ\text{C}$ (see Figure 16)	-	376		ns
Q_{rr}	Reverse recovery charge		-	2.8		μC
I_{RRM}	Reverse recovery current		-	15		A

1. Pulse width limited by safe operating area.

2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

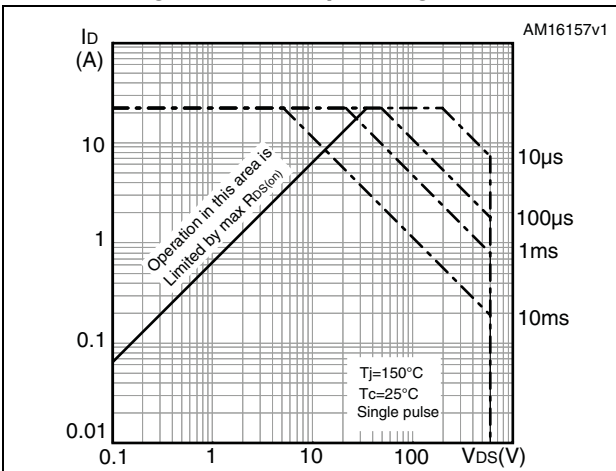


Figure 3. Thermal impedance

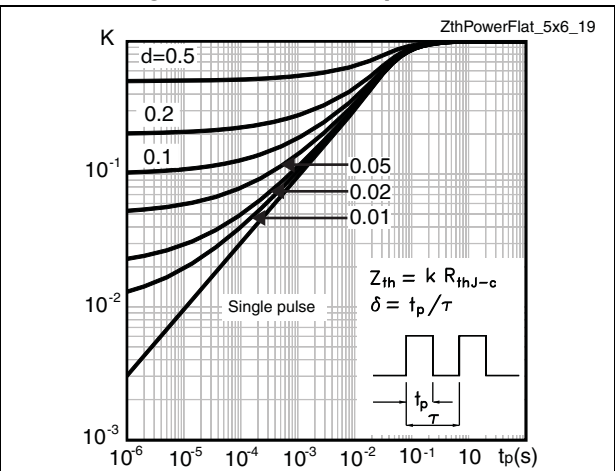


Figure 4. Output characteristics

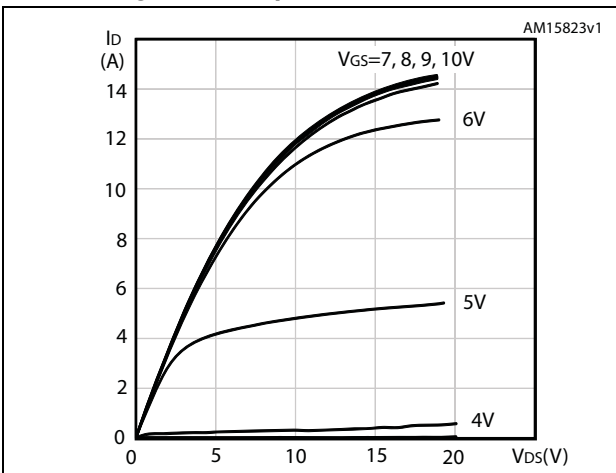


Figure 5. Transfer characteristics

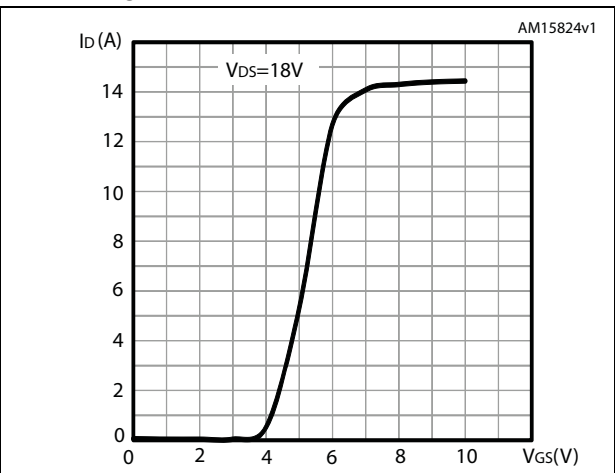


Figure 6. Gate charge vs gate-source voltage

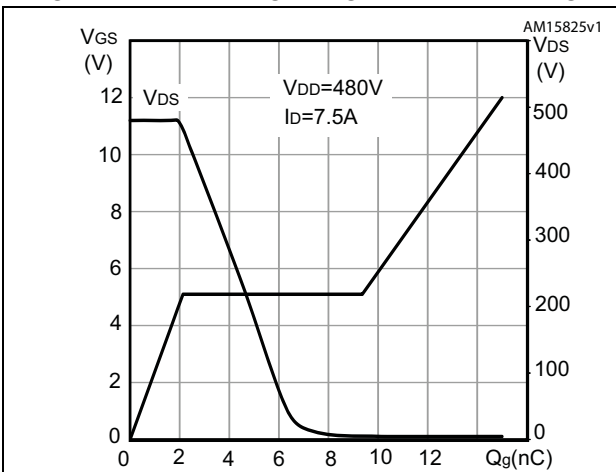


Figure 7. Static drain-source on-resistance

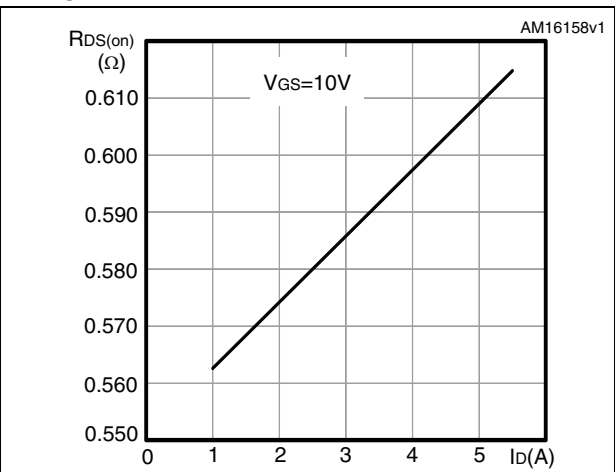


Figure 8. Capacitance variations

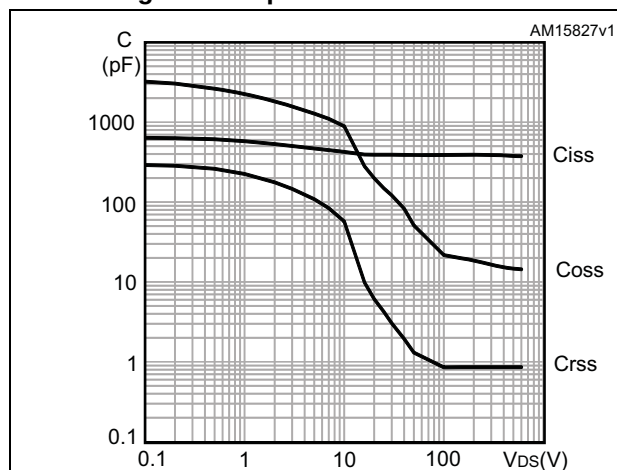


Figure 9. Output capacitance stored energy

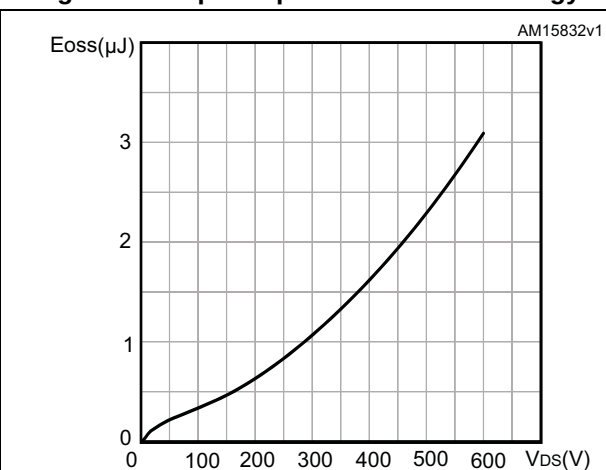


Figure 10. Normalized gate threshold voltage vs temperature

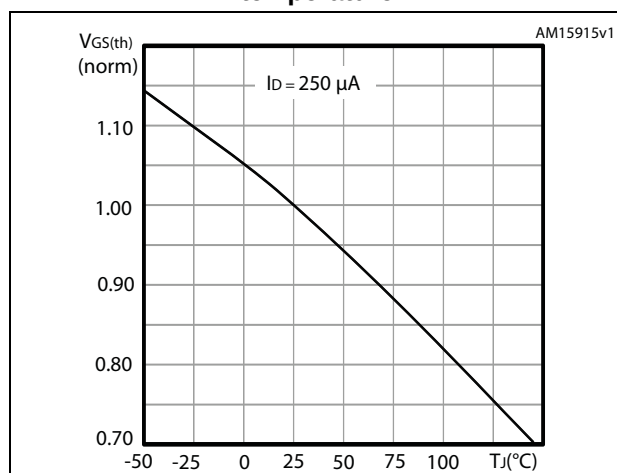


Figure 11. Normalized on-resistance vs temperature

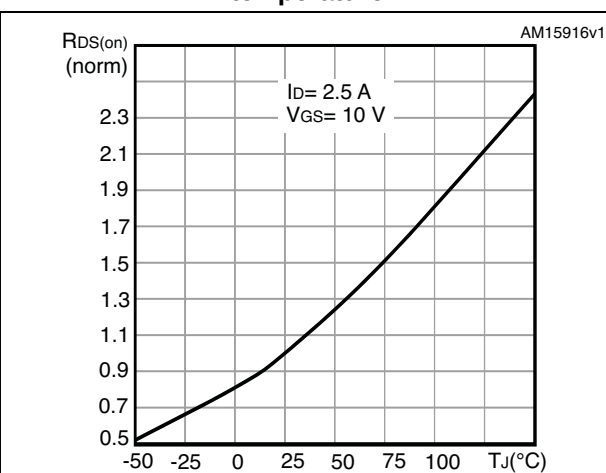


Figure 12. Normalized V(BR)DSS vs temperature

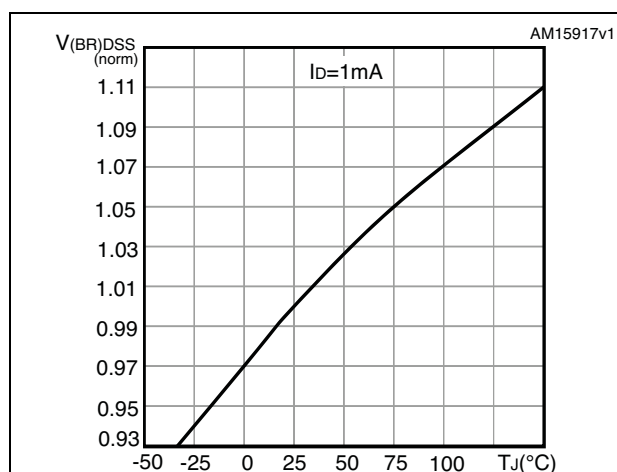
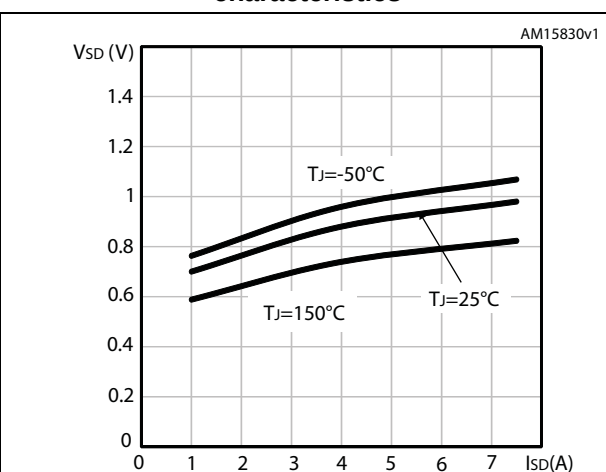


Figure 13. Source-drain diode forward characteristics



3 Test circuits

Figure 14. Switching times test circuit for resistive load

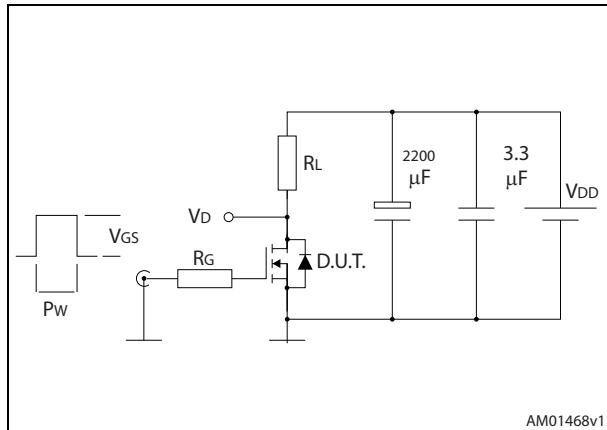


Figure 15. Gate charge test circuit

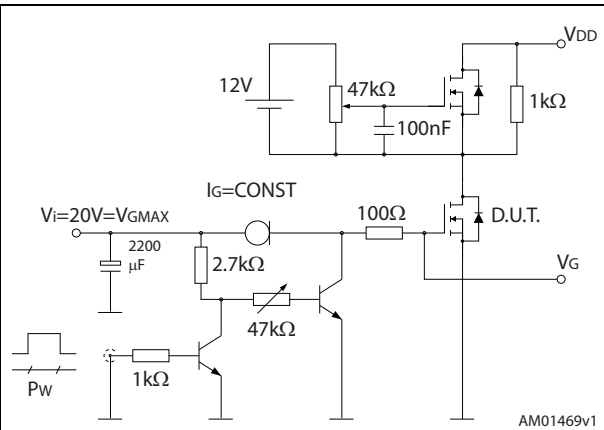


Figure 16. Test circuit for inductive load switching and diode recovery times

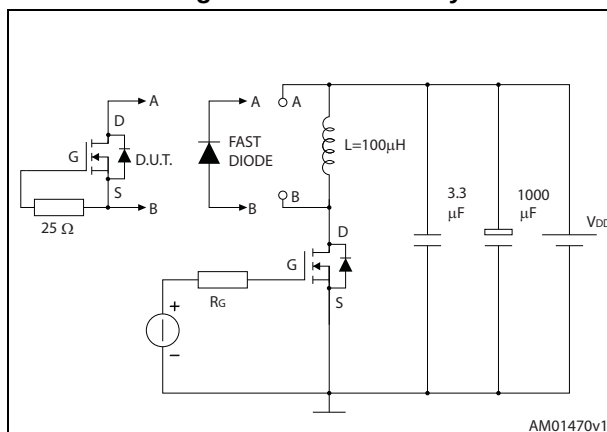


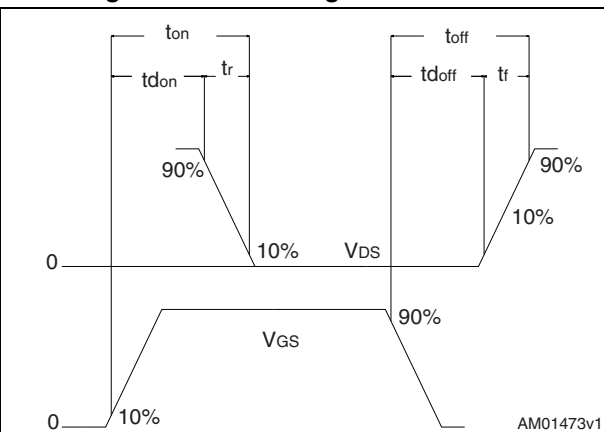
Figure 17. Unclamped inductive load test circuit



Figure 18. Unclamped inductive waveform



Figure 19. Switching time waveform



4 Package mechanical data

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Figure 20. PowerFLAT™ 5x6 HV drawing

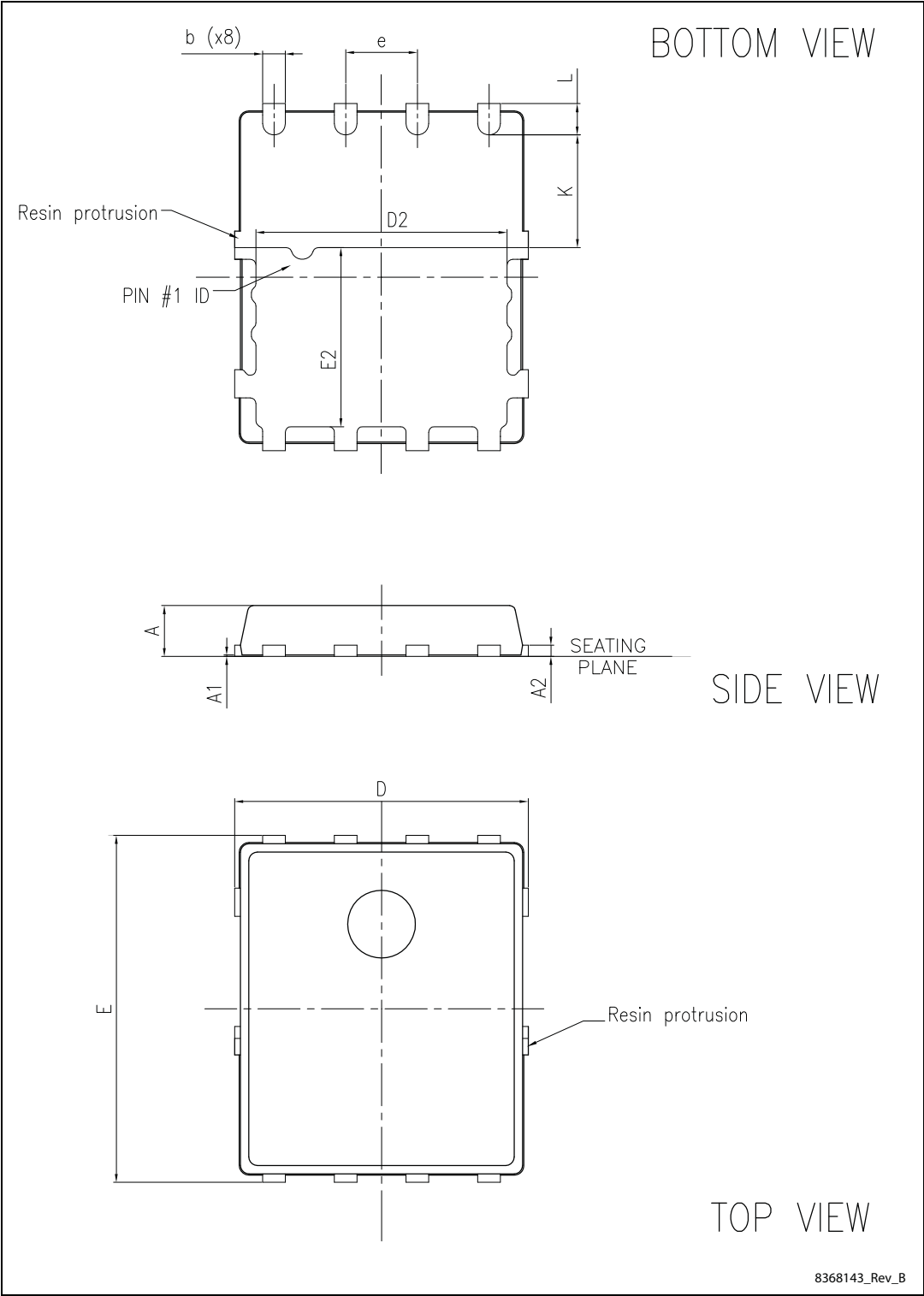
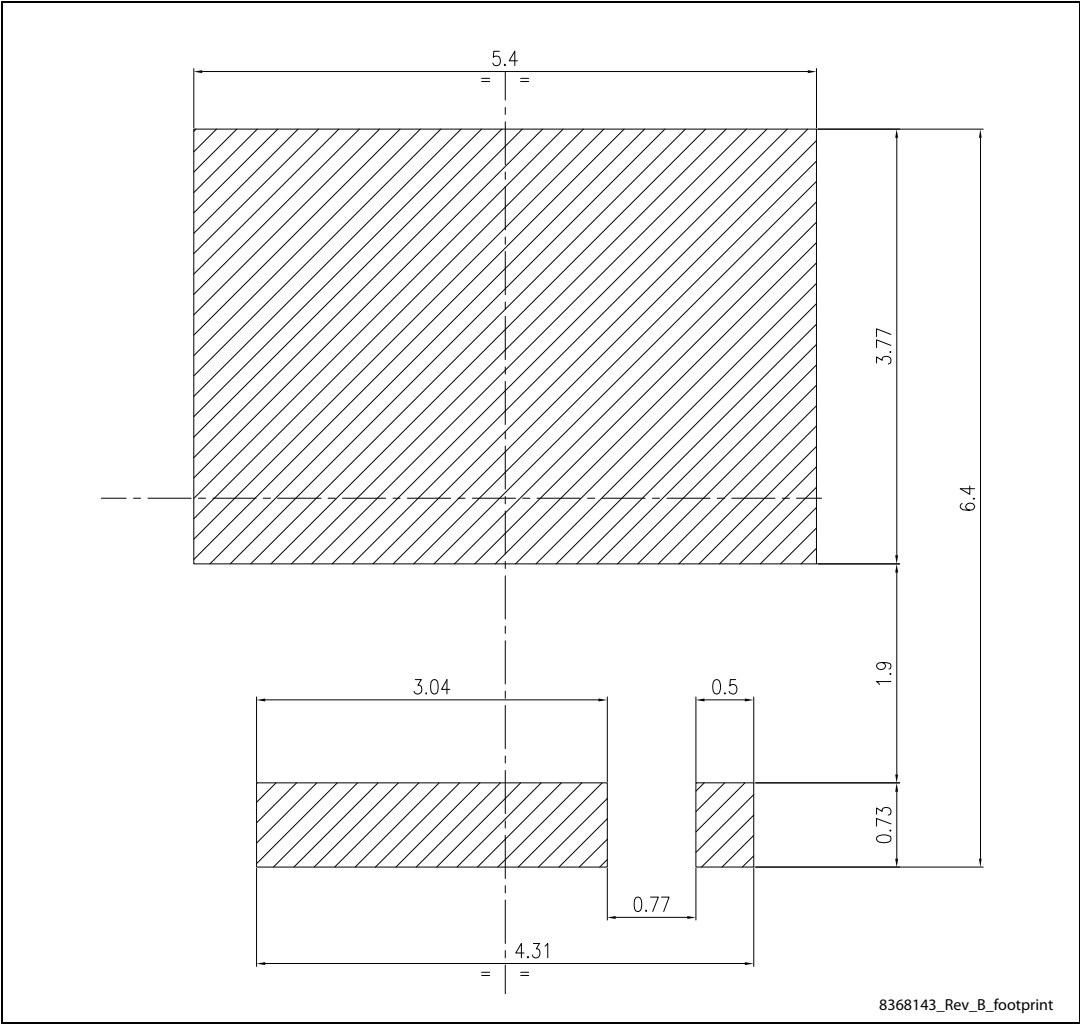


Table 8. PowerFLAT™ 5x6 HV mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D	5.00	5.20	5.40
E	5.95	6.15	6.35
D2	4.30	4.40	4.50
E2	3.10	3.20	3.30
e		1.27	
L	0.50	0.55	0.60
K	1.90	2.00	2.10

Figure 21. PowerFLAT™ 5x6 HV recommended footprint (dimensions are in mm)



5 Packaging mechanical data

Figure 22. PowerFLAT™ 5x6 tape^(a)

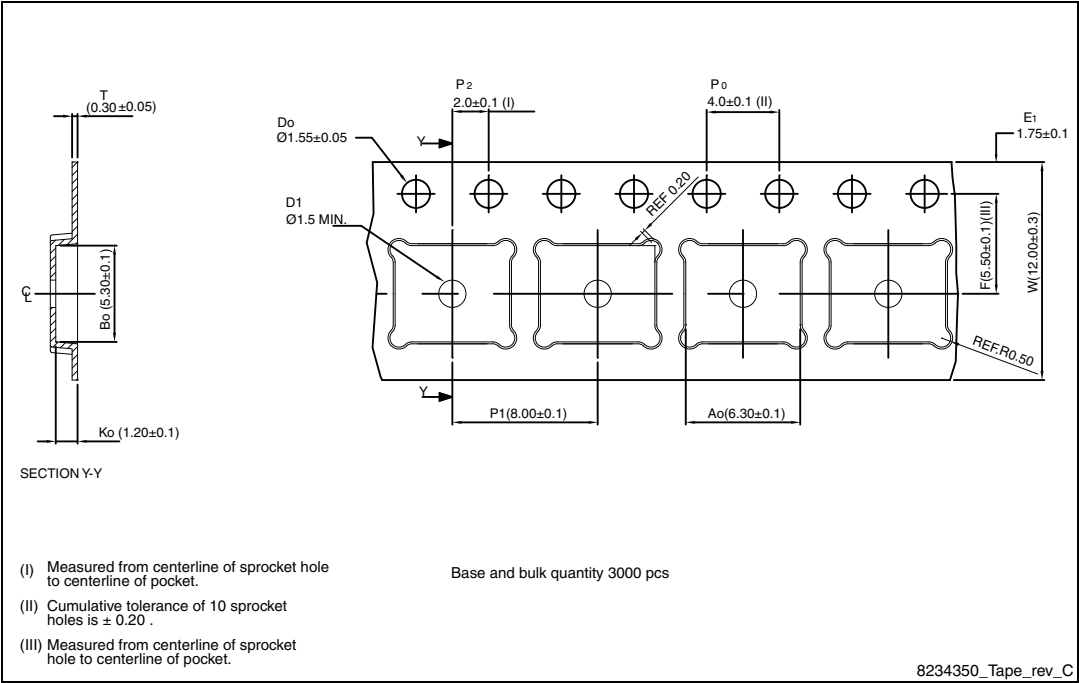
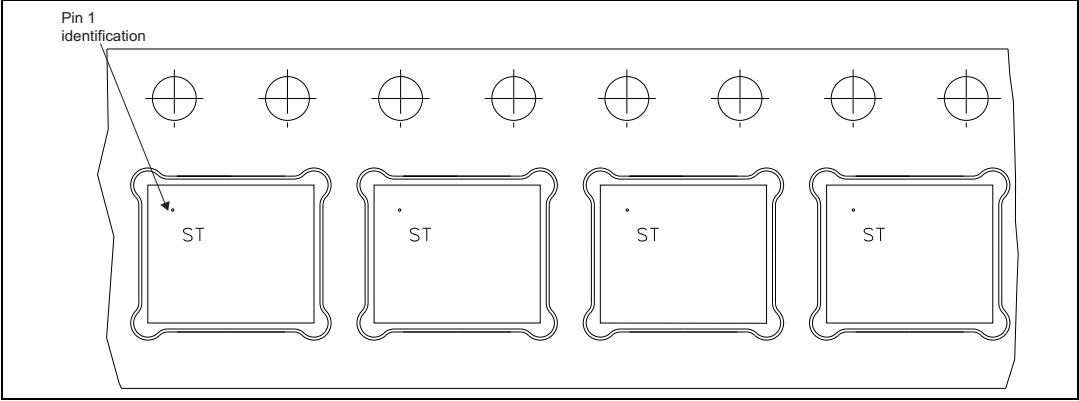


Figure 23. PowerFLAT™ 5x6 package orientation in carrier tape.



a. All dimensions are in millimeters.

Technical drawing of a reel carrier, showing top, side, and core detail views. Dimensions are in millimeters.

Top View (Left): Circular view showing the reel carrier with six pockets. Key dimensions include:

- Overall diameter: $\varnothing 330 (+0/-4.0)$
- Inner diameter: $\varnothing 25.00$
- Radius: $R1.90$
- Distance from center to pocket center: 4.00
- Distance from center to pocket edge: 2.50
- Distance from center to pocket corner: 1.10
- Distance from center to pocket corner: 0.40
- Distance from center to pocket corner: 1.00

Top View (Right): Circular view showing the reel carrier with six pockets. Key dimensions include:

- Overall diameter: $\varnothing 330 (+0/-4.0)$
- Inner diameter: $\varnothing 25.00$
- Distance from center to pocket center: 4.00
- Distance from center to pocket edge: 2.50
- Distance from center to pocket corner: 1.10
- Distance from center to pocket corner: 0.40
- Distance from center to pocket corner: 1.00

Side View (Top): Shows the reel carrier with six pockets. Key dimensions include:

- Overall diameter: $\varnothing 330 (+0/-4.0)$
- Inner diameter: $\varnothing 25.00$
- Distance from center to pocket center: 4.00
- Distance from center to pocket edge: 2.50
- Distance from center to pocket corner: 1.10
- Distance from center to pocket corner: 0.40
- Distance from center to pocket corner: 1.00

Side View (Bottom): Shows the reel carrier with six pockets. Key dimensions include:

- Overall diameter: $\varnothing 330 (+0/-4.0)$
- Inner diameter: $\varnothing 25.00$
- Distance from center to pocket center: 4.00
- Distance from center to pocket edge: 2.50
- Distance from center to pocket corner: 1.10
- Distance from center to pocket corner: 0.40
- Distance from center to pocket corner: 1.00

Core Detail (Bottom Left): Shows the core detail of the reel carrier. Key dimensions include:

- Overall diameter: $\varnothing 21.2$
- Inner diameter: $\varnothing 13.00$
- Distance from center to pocket center: 4.00
- Distance from center to pocket edge: 2.50
- Distance from center to pocket corner: 1.10
- Distance from center to pocket corner: 0.40
- Distance from center to pocket corner: 1.00

ESD LOGO: A logo indicating Electrostatic Discharge (ESD) protection.

W3: $11.9/15.4$

W2: $18.4 (max)$

W1: $12.4 (+2/-0)$

W4: $1.70 (+2/-0)$

W5: 1.90

W6: 2.50

W7: 1.90

W8: 2.50

W9: 1.90

W10: 2.50

W11: 1.90

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W128: 2.50

W129: 1.90

W130: $$

6 Revision history

Table 9. Document revision history

Date	Revision	Changes
28-Oct-2013	1	First release.
26-Mar-2014	2	Document status promoted from preliminary to production data. Minor text changes.

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(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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